

# **BUL810**

# HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- SGS-THOMSON PREFERRED SALESTYPE
- HIGH VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- LOW BASE-DRIVE REQUIREMENTS
- VERY HIGH SWITCHING SPEED
- FULLY CHARACTERIZED AT 125°C

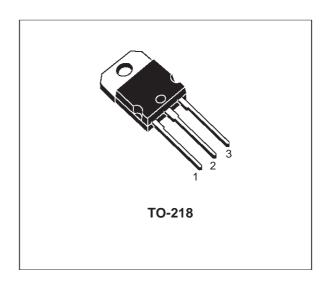
#### **APPLICATIONS**

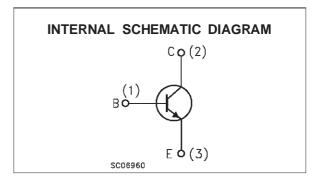
- ELECTRONIC TRANSFORMER FOR HALOGEN LAMPS
- ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING
- SWITCH MODE POWER SUPPLIES



The BUL810 is manufactured using high voltage Multiepitaxial Mesa technology for cost-effective high performance. It uses a Hollow Emitter structure to enhance switching speeds.

The BUL series is designed for use in lighting applications and low cost switch-mode power supplies.





#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-Emitter Voltage (V <sub>BE</sub> = 0)	1000	V
V <sub>CEO</sub>	Collector-Emitter Voltage (I <sub>B</sub> = 0)	450	V
$V_{EBO}$	Emitter-Base Voltage (I <sub>C</sub> = 0)	9	V
Ic	Collector Current	15	Α
I <sub>CM</sub>	Collector Peak Current (t <sub>p</sub> < 5 ms)	22	А
I <sub>B</sub>	Base Current	5	А
I <sub>BM</sub>	Base Peak Current (t <sub>p</sub> < 5 ms)	10	А
P <sub>tot</sub>	Total Dissipation at T <sub>c</sub> = 25 °C	125	W
T <sub>stg</sub>	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

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#### THERMAL DATA

ſ	R <sub>thj-case</sub>	Thermal	Resistance	Junction-Case	Max	1	°C/W
	$R_{thj-amb}$	Thermal	Resistance	Junction-Ambient	Max	30	°C/W

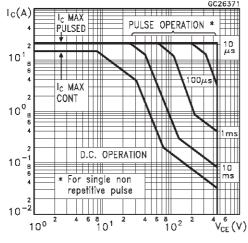
# **ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25$ °C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I <sub>CES</sub>	Collector Cut-off Current (V <sub>BE</sub> = 0)	V <sub>CE</sub> = 1000 V V <sub>CE</sub> = 1000 V T <sub>j</sub> = 125 °C			100 500	μA μA
I <sub>CEO</sub>	Collector Cut-off Current (I <sub>B</sub> = 0)	V <sub>CE</sub> = 450 V			250	μА
V <sub>CEO(sus)</sub>	Collector-Emitter Sustaining Voltage	I <sub>C</sub> = 100 mA L = 25 mH	450			V
$V_{EBO}$	Emitter-Base Voltage (I <sub>C</sub> = 0)	I <sub>E</sub> = 10 mA	9			V
V <sub>CE(sat)*</sub>	Collector-Emitter Saturation Voltage	$I_C = 5 \text{ A}$ $I_B = 1 \text{ A}$ $I_C = 8 \text{ A}$ $I_B = 1.6 \text{ A}$ $I_C = 12 \text{ A}$ $I_B = 2.4 \text{ A}$			1 1.5 5	V V V
V <sub>BE(sat)*</sub>	Base-Emitter Saturation Voltage	I <sub>C</sub> = 5 A I <sub>B</sub> = 1 A I <sub>C</sub> = 8 A I <sub>B</sub> = 1.6 A			1.3 1.6	V V
h <sub>FE</sub> *	DC Current Gain	$I_{C} = 5 \text{ A}$ $V_{CE} = 5 \text{ V}$ $I_{C} = 10 \text{ mA}$ $V_{CE} = 5 \text{ V}$	10 10		40	
t <sub>s</sub> t <sub>f</sub>	INDUCTIVE LOAD Storage Time Fall Time			1.5 55	2.3 110	μs ns
t <sub>s</sub> t <sub>f</sub>	INDUCTIVE LOAD Storage Time Fall Time	$\begin{array}{cccccccccccccccccccccccccccccccccccc$		1.9 80		μs ns

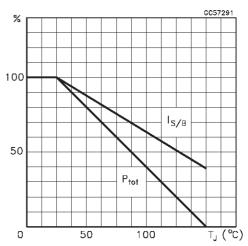
<sup>\*</sup> Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %

# Safe Operating Areas

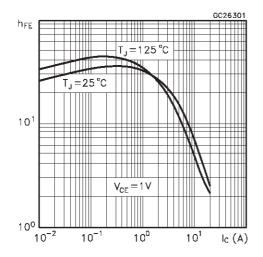
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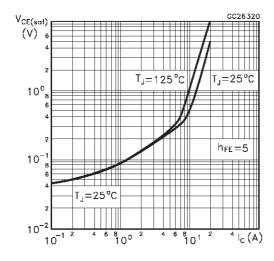
# **Derating Curve**



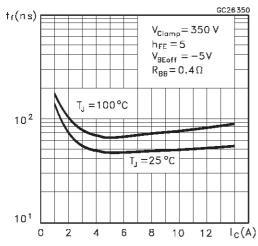
#### DC Current Gain



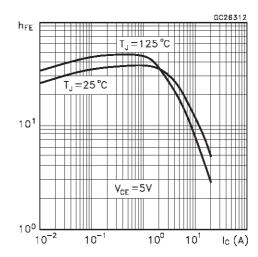
# Collector Emitter Saturation Voltage



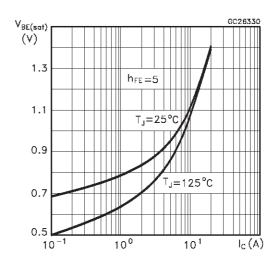
#### Inductive Fall Time



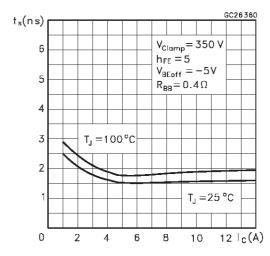
#### DC Current Gain



#### Base Emitter Saturation Voltage

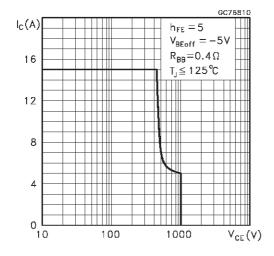


# Inductive Storage Time

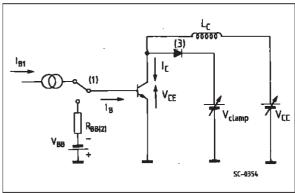


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## Reverse Biased SOA



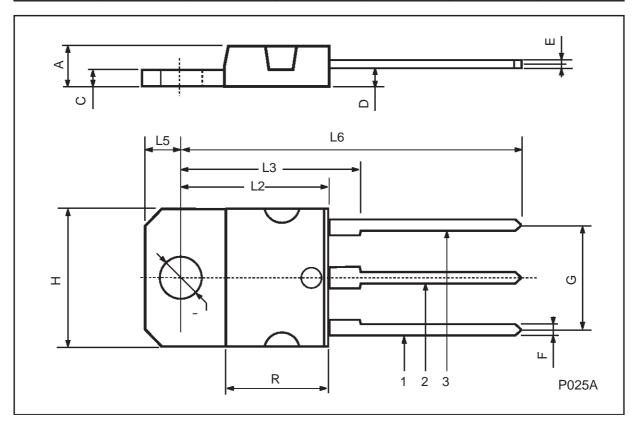
## RBSOA and Inductive Load Switching Test Circuits



- (1) Fast electronic switch (2) Non-inductive Resistor (3) Fast recovery rectifier

# TO-218 (SOT-93) MECHANICAL DATA

DIM.	mm			inch			
Diwi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	4.7		4.9	0.185		0.193	
С	1.17		1.37	0.046		0.054	
D		2.5			0.098		
E	0.5		0.78	0.019		0.030	
F	1.1		1.3	0.043		0.051	
G	10.8		11.1	0.425		0.437	
Н	14.7		15.2	0.578		0.598	
L2	_		16.2	_		0.637	
L3		18			0.708		
L5	3.95		4.15	0.155		0.163	
L6		31			1.220		
R	_		12.2	_		0.480	
Ø	4		4.1	0.157		0.161	



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